

SUM110N04-2m3L

Vishay Siliconix

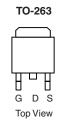
N-Channel 40-V (D-S) 175 °C MOSFET

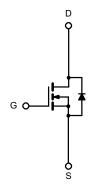
PRODUCT SUMMARY				
V _{(BR)DSS} (V)	r _{DS(on)} (Ω)	I _D (A)		
40	0.0023 at V _{GS} = 10 V	110 ^a		
	0.003 at V _{GS} = 4.5 V			

FEATURES

- TrenchFET[®] Power MOSFET
- 100 % R_g Tested







N-Channel MOSFET

Ordering Information: SUM110N04-2m3L-E3 (Lead (Pb)-free)

ABSOLUTE MAXIMUM RATINGS $T_A = 2$	25 °C, unless other	wise noted		
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V _{DS}	40	v
Gate-Source Voltage		V _{GS}	± 20	v
Continuous Drain Current (T ₁ = 175 °C)	T _C = 25 °C		110 ^a	
	T _C = 125 °C	I D	110 ^a	А
Pulsed Drain Current		I _{DM}	440	А
Avalanche Current, Single Pulse		I _{AS}	75	
Repetitive Avalanche Energy, Single Pulse	L = 0.1 mH	E _{AS}	280	mJ
Mauine Davies Disaination	T _C = 25 °C	Р	375 ^b	14/
Maximum Power Dissipation	T _A = 25 °C	P _D	3.75	- w
Operating Junction and Storage Temperature Range	•	T _J , T _{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS				
Parameter		Symbol	Typical	Unit
Junction-to-Ambient	PCB Mount ^c	R _{thJA}	40	°C/W
Junction-to-Case (Drain)		R _{thJC}	0.4	0/11

Notes:

a. Package limited.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_{D} = 250 \mu A$	40			v	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1		3	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA	
		V_{DS} = 40 V, V_{GS} = 0 V, T_{J} = 125 °C			50		
		V_{DS} = 40 V, V_{GS} = 0 V, T_{J} = 175 °C			10	mA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	120			А	
Drain-Source On-State Resistance ^a		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A}$		0.0019	0.0023	Ω	
	(DOC)	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.0024	0.003		
	r _{DS(on)}	V_{GS} = 10 V, I _D = 30 A, T _J = 125 °C			0.0035		
		V_{GS} = 10 V, I_D = 30 A, T_J = 175 °C			0.0044		
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 30 \text{ A}$	30			S	
Dynamic ^b							
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		13600		pF	
Output Capacitance	C _{oss}			1420			
Reverse Transfer Capacitance	C _{rss}			1040			
Total Gate Charge ^c	Qg			240	360	nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 110 \text{ A}$		53			
Gate-Drain Charge ^c	Q _{gd}			55			
Gate Resistance	R _g	f = 1.0 MHz	0.65	1.3	2	Ω	
Turn-On Delay Time ^c	t _{d(on)}			25	40		
Rise Time ^c	t _r	V_{DD} = 30 V, R_L = 0.27 Ω		100	150	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$\text{I}_\text{D}\cong$ 110 A, V_GEN = 10 V, R_g = 2.5 Ω		125	190		
Fall Time ^c	t _f			200	300		
Source-Drain Diode Ratings and Cha	aracteristics	_C = 25 °C ^b					
Continuous Current	۱ _S				110		
Pulsed Current	I _{SM}				240	A	
Forward Voltage ^a	V _{SD}	I _F = 85 A, V _{GS} = 0 V		1.1	1.5	V	
Reverse Recovery Time	t _{rr}			56	85	ns	
Peak Reverse Recovery Charge	I _{RM(REC)}	I _F = 85 A, di/dt = 100 A/μs		3.1	4.7	А	
Reverse Recovery Charge	Q _{rr}			0.087	0.2	μC	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

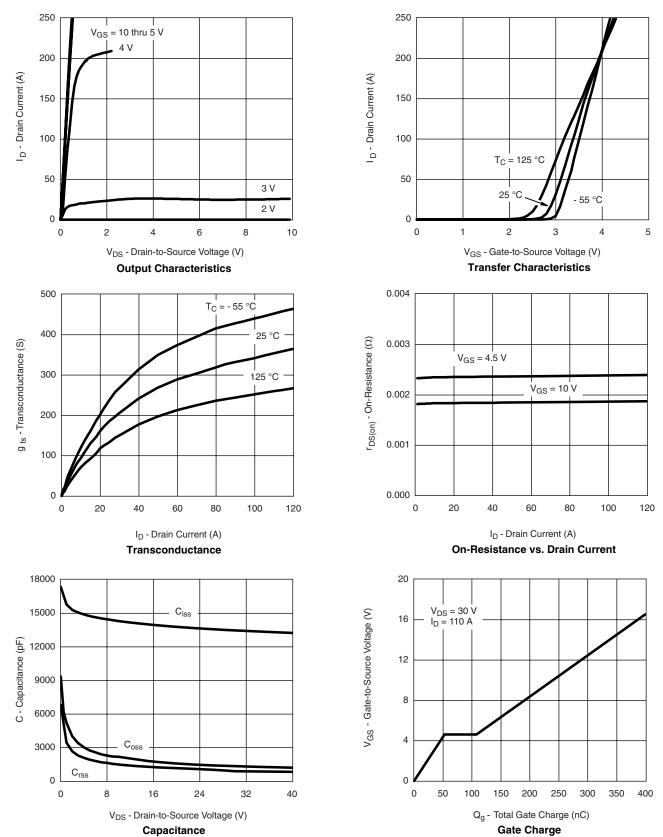
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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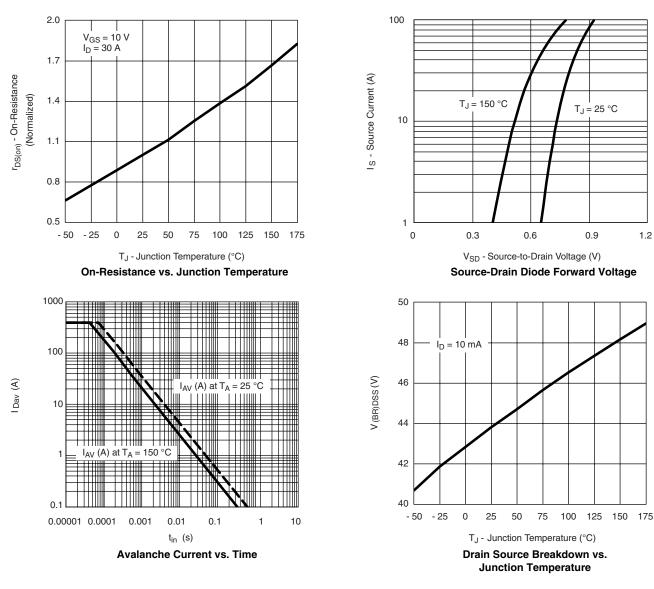
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



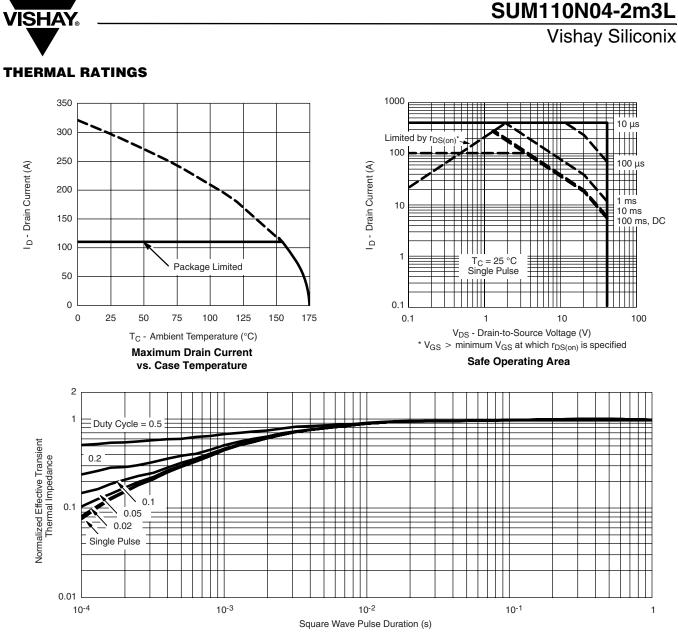
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Normalized Thermal Transient Impedance, Junction-to-Case

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